

P-Channel 30-V (D-S) MOSFET

| PRODUCT SUMMARY | | | | | | |
|---------------------|------------------------------------|--|---------|--|--|--|
| V _{DS} (V) | $R_{DS(on)}\left(\Omega\right)$ | I _D (A) ^d Q _g (Typ. | | | | |
| - 30 | 0.0092 at V _{GS} = - 10 V | - 13.5 | 29.5 nC | | | |
| - 30 | 0.0128 at $V_{GS} = -4.5$ V | - 11.6 | | | | |

FEATURES

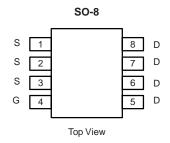
- Halogen-free
- TrenchFET® Power MOSFET
- 100 % R_g Tested
- 100 % UIS Tested

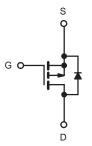


RoHS

APPLICATIONS

- Load Switch
- · Notebook Adaptor Switch





P-Channel MOSFET

| Parameter | Symbol | Limit | Unit | |
|---|------------------------|-----------------------------------|------------------------|-----|
| Drain-Source Voltage | | V _{DS} | - 30 | V |
| Gate-Source Voltage | | V_{GS} | ± 20 | V |
| | T _C = 25 °C | | - 13.5 | |
| Continuous Drain Current (T _{.1} = 150 °C) | T _C = 70 °C | | - 11.9 | |
| Continuous Diain Curient (1) = 130 °C) | T _A = 25 °C | l _D | - 10.9 ^{a, b} | |
| | T _A = 70 °C | | - 8.6 ^{a, b} | |
| Pulsed Drain Current | | I _{DM} | - 50 | A |
| Continuous Source-Drain Diode Current | T _C = 25 °C | | - 4.1 | |
| Continuous Source-Drain Diode Current | T _A = 25 °C | I _S | - 2.2 ^{a, b} | |
| Avalanche Current | 1 0411 | I _{AS} | - 20 | |
| Single-Pulse Avalanche Energy | L = 0.1 mH | E _{AS} | 20 | mJ |
| | T _C = 25 °C | | 5.0 | |
| Manifestor Bernar Biodination | T _C = 70 °C | | 3.2 | 14/ |
| Maximum Power Dissipation | T _A = 25 °C | P _D | 2.7 ^{a, b} | W |
| | T _A = 70 °C | | 1.7 ^{a, b} | |
| Operating Junction and Storage Temperature Rang | e | T _J , T _{stg} | - 55 to 150 | °C |

| THERMAL RESISTANCE RATINGS | | | | | | |
|---|--------------|--------------------|---------|---------|------|--|
| Parameter | | Symbol | Typical | Maximum | Unit | |
| Maximum Junction-to-Ambient ^{a, c} | t ≤ 10 s | R _{thJA} | 38 | 46 | °C/W | |
| Maximum Junction-to-Foot | Steady State | R _{th,IF} | 20 | 25 | 1 | |

Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. t = 10 s.
- c. Maximum under Steady State conditions is 85 °C/W.
- d. Based on $T_C = 25$ °C.



| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
|---|--|--|-------|--------|-------|------|--|
| Static | | | | I I | | ı | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 \text{ V}, I_{D} = -250 \mu\text{A}$ | - 30 | | | V | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | I _D = - 250 µA | | - 34 | | mV/ | |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | I _D = - 250 μA | | 5.3 | | °C | |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = -250 \mu\text{A}$ | - 1.0 | | - 3.0 | V | |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 25 \text{ V}$ | | | ± 100 | nA | |
| Zana Oata Vallana Brain Oamani | I _{DSS} | $V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$ | | | - 1 | | |
| Zero Gate Voltage Drain Current | | V _{DS} = - 30 V, V _{GS} = 0 V, T _J = 55 °C | | | - 5 | μA | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge -10 \text{ V}, V_{GS} = -10 \text{ V}$ | - 30 | | | Α | |
| | , , | V _{GS} = - 10 V, I _D = - 10 A | | 0.007 | | Ω | |
| Drain-Source On-State Resistance ^a | $R_{DS(on)}$ | V _{GS} = - 4.5 V, I _D = - 8 A | | 0.0115 | | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = - 10 V, I _D = - 10 A | | 28 | | S | |
| Dynamic ^b | | | | · | | | |
| Input Capacitance | C _{iss} | | | 2550 | | pF | |
| Output Capacitance | C _{oss} | V _{DS} = - 15 V, V _{GS} = 0 V, f = 1 MHz | | 455 | | | |
| Reverse Transfer Capacitance | C _{rss} | | | 390 | | | |
| · | | V _{DS} = - 15 V, V _{GS} = - 10 V, I _D = - 10 A | | 57 | 86 | 86 | |
| Total Gate Charge | Q _g V _{DS} = 13 V, V _{GS} = 10 V, I _D = 10 A | | 29.5 | 45 | | | |
| Gate-Source Charge | Q _{qs} | $V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -10 \text{ A}$ | | 8 | | nC | |
| Gate-Drain Charge | Q_{gd} | | | 22 | | | |
| Gate Resistance | R _g | f = 1 MHz | 0.5 | 2.2 | 4.4 | Ω | |
| Turn-On Delay Time | t _{d(on)} | | | 13 | 25 | | |
| Rise Time | t _r | $V_{DD} = -15 \text{ V}, R_{L} = 1.5 \Omega$ | | 12 | 24 | | |
| Turn-Off DelayTime | t _{d(off)} | $I_{D} \cong -10 \text{ A}, V_{GEN} = -10 \text{ V}, R_{q} = 1 \Omega$ | | 40 | 70 | | |
| Fall Time | t _f | Ü | | 9 | 18 | | |
| Turn-On Delay Time | t _{d(on)} | | | 48 | 80 | ns | |
| Rise Time | t _r | $V_{DD} = -15 \text{ V}, R_{L} = 1.5 \Omega$ | | 92 | 160 | | |
| Turn-Off DelayTime | t _{d(off)} | $I_D \cong -10 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_q = 1 \Omega$ | | 34 | 60 | | |
| Fall Time | t _f | , and the second | | 19 | 35 | | |
| Drain-Source Body Diode Characteris | | | | | | | |
| Continous Source-Drain Diode Current | I _S | T _C = 25 °C | | | - 4.1 | _ | |
| Pulse Diode Forward Current | I _{SM} | - | | | - 60 | A | |
| Body Diode Voltage | V _{SD} | I _S = - 3 A, V _{GS} = 0 V | | - 0.75 | - 1.2 | V | |
| Body Diode Reverse Recovery Time | t _{rr} | - 55 | | 27 | 45 | ns | |
| Body Diode Reverse Recovery Charge | Q _{rr} | I _F = -10 A, dl/dt = 100 A/μs, T _J = 25 °C | | 16 | 27 | nC | |
| Reverse Recovery Fall Time | t _a | | | 12 | | | |
| Reverse Recovery Rise Time | t _b | | | 15 | | ns | |

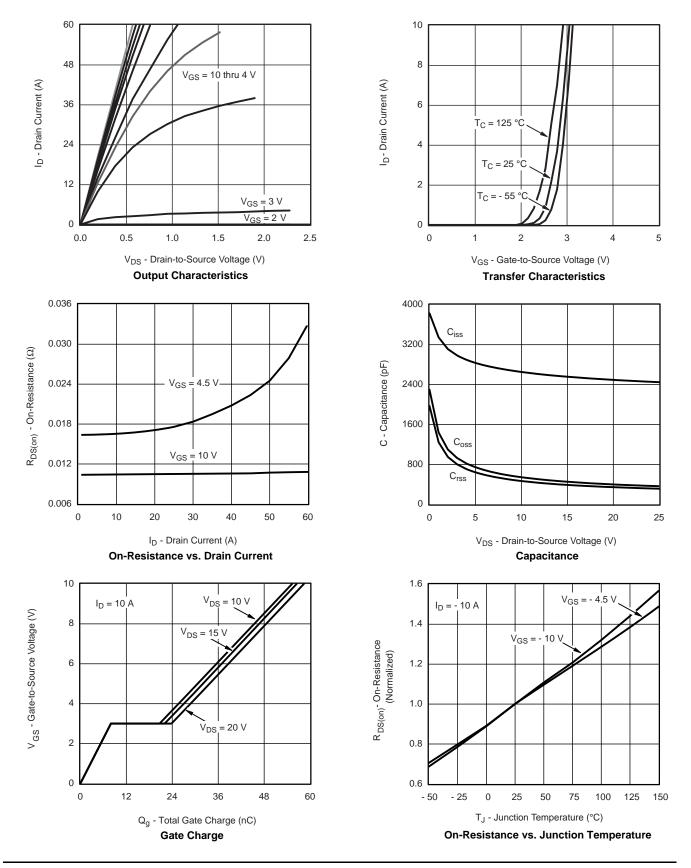
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

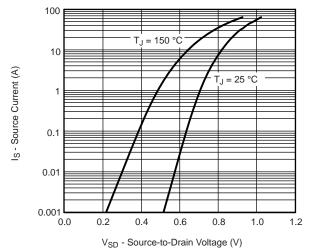


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

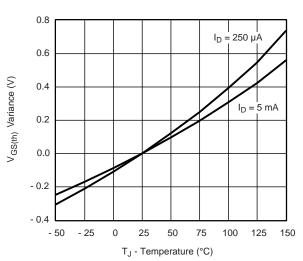




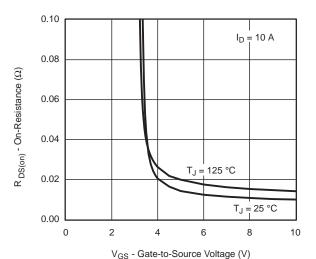
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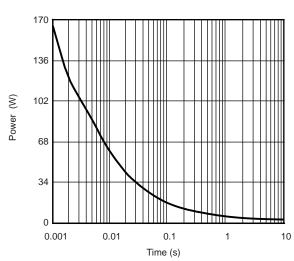
Source-Drain Diode Forward Voltage



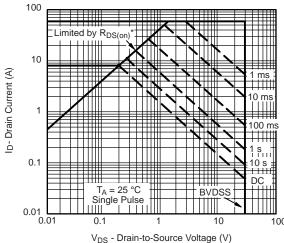
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

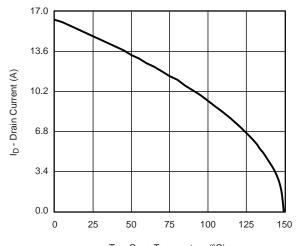


* V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified

Safe Operating Area

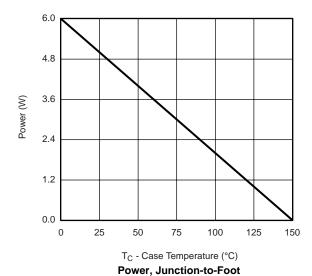


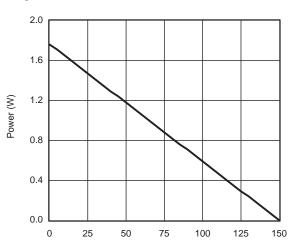
MOSFET TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



 $T_{\mbox{\scriptsize C}}$ - Case Temperature (°C)

Current Derating*



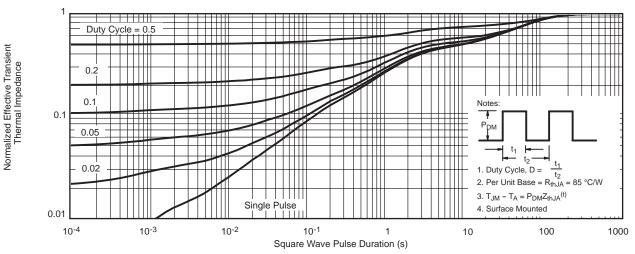


 $\label{eq:TA-Ambient Temperature (°C)}$ Power Derating, Junction-to-Ambient

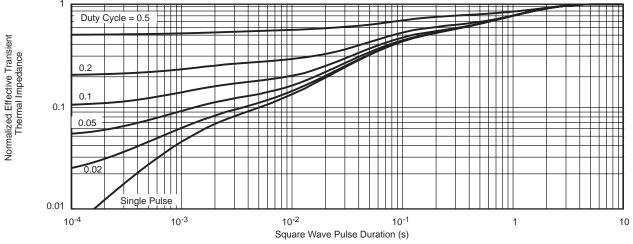
^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient

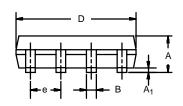


Normalized Thermal Transient Impedance, Junction-to-Foot



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







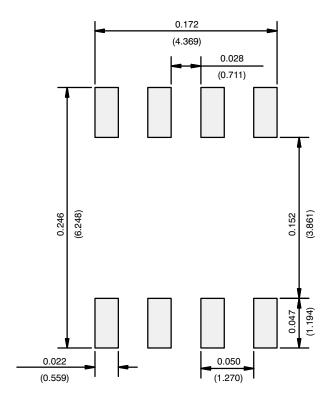
| | MILLIM | IETERS | INCHES | | | |
|------------------------------|--------|--------|--------|-------|--|--|
| DIM | Min | Max | Min | Max | | |
| Α | 1.35 | 1.75 | 0.053 | 0.069 | | |
| A ₁ | 0.10 | 0.20 | 0.004 | 0.008 | | |
| В | 0.35 | 0.51 | 0.014 | 0.020 | | |
| С | 0.19 | 0.25 | 0.0075 | 0.010 | | |
| D | 4.80 | 5.00 | 0.189 | 0.196 | | |
| E | 3.80 | 4.00 | 0.150 | 0.157 | | |
| е | 1.27 | BSC | 0.050 |) BSC | | |
| Н | 5.80 | 6.20 | 0.228 | 0.244 | | |
| h | 0.25 | 0.50 | 0.010 | 0.020 | | |
| L | 0.50 | 0.93 | 0.020 | 0.037 | | |
| q | 0° | 8° | 0° | 8° | | |
| S | 0.44 | 0.64 | 0.018 | 0.026 | | |
| FCN: C-06527-Pay I 11-San-06 | | | | | | |

ECN: C-06527-Rev. I, 11-Sep-06

DWG: 5498



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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